

Increased AW5005DNRZ FAB Capability Notice

PCN No.	201802001			PCN Date	2018/02/06
Item	Increased AW5005DNRZ FAB capability Notice				
Contacts	Scott Zhang	Phone	+86-21-54271166 #6899	Dept.	QA
PCN Form					
<input type="checkbox"/>	Wafer material	<input type="checkbox"/>	Wafer technology	<input type="checkbox"/>	Wafer factory
<input type="checkbox"/>	Assembly material	<input type="checkbox"/>	Assembly technology	<input type="checkbox"/>	Assembly factory
<input type="checkbox"/>	Design	<input type="checkbox"/>	Testing process	<input type="checkbox"/>	Testing factory
<input type="checkbox"/>	Electrical properties	<input type="checkbox"/>	Packaging/Label/Logistics	<input type="checkbox"/>	EOL
<input checked="" type="checkbox"/>	Production-line expanded	<input type="checkbox"/>	Others:		
Sample					
<input type="checkbox"/>	Can be offered				
<input checked="" type="checkbox"/>	No needed				
<input type="checkbox"/>	Can be offered soon	Estimated offered date			

Change Information

Change Description	
Increased AW5005DNRZ FAB capacity of TSMC, the FAB will change from FAB6 to FAB6&FABA10.	
Affected Area	
AW5005DNRZ	
Reason for Change	
Increased FAB capability	
Influence Assessment	
This change does not affect the function, performance and application of the product.	
Proposed Implementation Date	2018/04/06

For any questions related to this notice, please contact the quality department or local sales representative of awinic:

Name	Position	E-mail	Phone
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